

Ultradur® B 4300 G6 Polybutylene Terephthalate (PBT)

Ultradur B 4300 G6 is an easy flowing injection molding PBT with 30% glass fiber reinforcement for rigid, tough, and dimensionally stable parts.

Applications

Typical applications include windshield wiper arms, printed circuit boards, housings, consoles, contact carriers, and covers.

PHYSICAL	ISO Test Method	Property Value
Density, g/cm ³	1183	1.53
Viscosity Number, cm³/g	1628	102
Mold Shrinkage, parallel, %	294-4	0.34
Mold Shrinkage, normal, %	294-4	1.07
Moisture, %	62	
(50% RH)		0.2
(Saturation)		0.4
RHEOLOGICAL	ISO Test Method	Property Value
Melt Volume Rate (250 °C/2.16 Kg), cc/10min.	1133	11
	1133 ISO Test Method	
Melt Volume Rate (250 °C/2.16 Kg), cc/10min.		11
Melt Volume Rate (250 °C/2.16 Kg), cc/10min. MECHANICAL	ISO Test Method	11
Melt Volume Rate (250 °C/2.16 Kg), cc/10min. MECHANICAL Tensile Modulus, MPa	ISO Test Method	11 Property Value
Melt Volume Rate (250 °C/2.16 Kg), cc/10min. MECHANICAL Tensile Modulus, MPa 23°C	ISO Test Method 527	11 Property Value
Melt Volume Rate (250 °C/2.16 Kg), cc/10min. MECHANICAL Tensile Modulus, MPa 23°C Tensile stress at break, MPa	ISO Test Method 527	11 Property Value 10,000
Melt Volume Rate (250 °C/2.16 Kg), cc/10min. MECHANICAL Tensile Modulus, MPa 23 °C Tensile stress at break, MPa -40 °C	ISO Test Method 527	Property Value 10,000

23°C		2.5
Flexural Strength, MPa	178	
23°C		200
Flexural Modulus, MPa	178	
23°C		8,800
Tensile Creep Modulus (1000h), MPa	899	7,500
IMPACT	ISO Test Method	Property Value
Charpy Notched, kJ/m ²	179	
23°C		11
Charpy Unnotched, kJ/m ²	179	
-30°C		74
23°C		67
THERMAL	ISO Test Method	Property Value
Melting Point, °C	3146	223
HDT A, ° C	75	215
HDT A, ° C	75 75	215
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel,		220
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C	75	220 0.25 X10-4
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL	75 ISO Test Method	220 0.25 X10-4 Property Value
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL Comparative Tracking Index	75 ISO Test Method IEC 60112	220 0.25 X10-4 Property Value 375
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL Comparative Tracking Index Volume Resistivity (Ohm-m)	ISO Test Method IEC 60112 IEC 60093	220 0.25 X10-4 Property Value 375 >1E13
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL Comparative Tracking Index Volume Resistivity (Ohm-m) Surface Resistivity (Ohm)	75 ISO Test Method IEC 60112 IEC 60093 IEC 60093	220 0.25 X10-4 Property Value 375 >1E13 1E13
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL Comparative Tracking Index Volume Resistivity (Ohm-m) Surface Resistivity (Ohm) Dielectric Constant (100 Hz)	75 ISO Test Method IEC 60112 IEC 60093 IEC 60093	220 0.25 X10-4 Property Value 375 >1E13 1E13 4
HDT B, ° C Coef. of Linear Thermal Expansion, Parallel, mm/mm °C ELECTRICAL Comparative Tracking Index Volume Resistivity (Ohm-m) Surface Resistivity (Ohm) Dielectric Constant (100 Hz) Dielectric Constant (1 MHz)	75 ISO Test Method IEC 60112 IEC 60093 IEC 600250 IEC 60250	220 0.25 X10-4 Property Value 375 >1E13 1E13 4 3.8

Electrical, °C		130
Flammability Rating, 1.5mm	UL94	НВ
Relative Temperature Index, 1.5mm	UL746B	
Mechanical w/ Impact, °C		105
Electrical, °C		130
Flammability Rating, 3.0mm	UL94	НВ
Relative Temperature Index, 3.0mm	UL746B	
Relative Temperature Index, 3.0mm Mechanical w/o Impact, °C	UL746B	140
	UL746B	140 125

Processing Guidelines

Material Handling

Max. Water content: 0.04%

To ensure optimum part performance, this product must be dried prior to molding and maintained at a moisture level of less than 0.04%. Dehumidifying or desiccant dryers operating at 100-120°C (212-248°F) for 4 hours drying time are recommended. Further information concerning safe handling procedures can be obtained from the Safety Data Sheet. Alternatively, please contact your BASF representative.

Typical Profile

Melt Temperature 250-270°C (482-518°F) Mold Temperature 60-100°C (140-212°F) Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures

This product can be processed over mold temperatures of 60-100°C (140-212°F); however, for optimizing surface appearance, dimensional stability and part performance, mold surface temperatures of at least 80°C (176°F) are preferred.

Pressures

Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. A maximum of 10 bar (145 psi) is recommended due to the risk of excessive shear.

Fill Rate

Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.

Note

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